DATASHEET

RELEASED 11/10

4-Bit Synchronous Counters

UT54ACS163/UT54ACTS163

Features

- Internal look-ahead for fast counting
- Carry output for n-bit cascading
- Synchronous counting
- Synchronously programmable
- 1.2µ CMOS
  - Latchup immune
- High speed
- Low power consumption
- Single 5 volt supply
- Available QML Q or V processes
- Flexible package
  - 16-pin DIP
  - 16-lead flatpack
- UT54ACS163 - SMD 5962-96554
- UT54ACTS163 - SMD 5962-96555

Description

The UT54ACS163 and the UT54ACTS163 are synchronous presettable 4-bit binary counters that feature internal carry look-ahead logic for high-speed counting designs. Synchronous operation occurs by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when instructed by the count-enable inputs and internal gating. A buffered clock input triggers the four flip-flops on the rising (positive-going) edge of the clock input waveform.

The counters are fully programmable (i.e., they may be preset to any number between 0 and 15). Presetting is synchronous; applying a low level at the load input disables the counter and causes the outputs to agree with the load data after the next clock pulse.

The clear function is synchronous and a low level at the clear input sets all four of the flip-flop outputs low after the next clock pulse. This synchronous clear allows the count length to be modified by decoding the Q outputs for the maximum count desired.

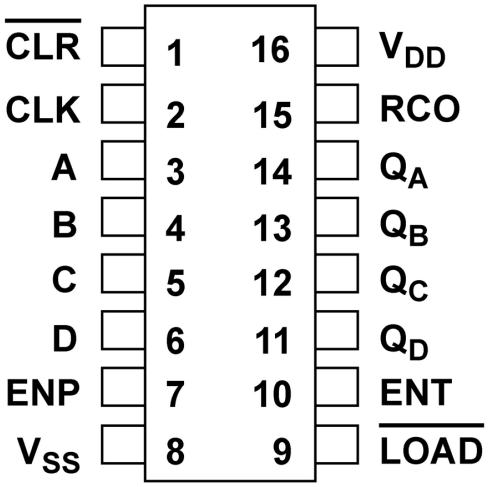
The counters feature a fully independent clock circuit. Changes at control inputs (ENP, ENT, or $\overline{\text{LOAD}}$) that modify the operating mode have no effect on the contents of the counter until clocking occurs. The function of the counter (whether enabled, disabled, loading, or counting) will be dictated solely by the conditions meeting the stable setup and hold times.

The devices are characterized over the full military temperature range of -55°C to +125°C.

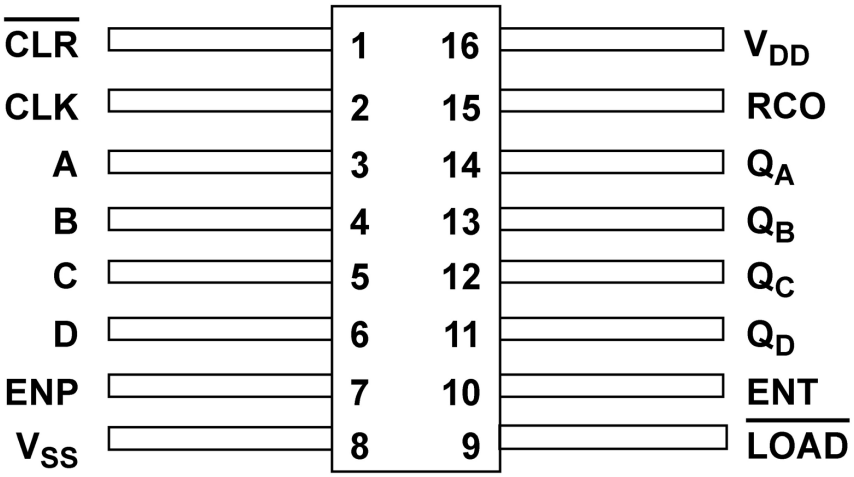
4-Bit Synchronous Counters

UT54ACS163/UT54ACTS163

Pinouts



16-Pin DIP
Top View

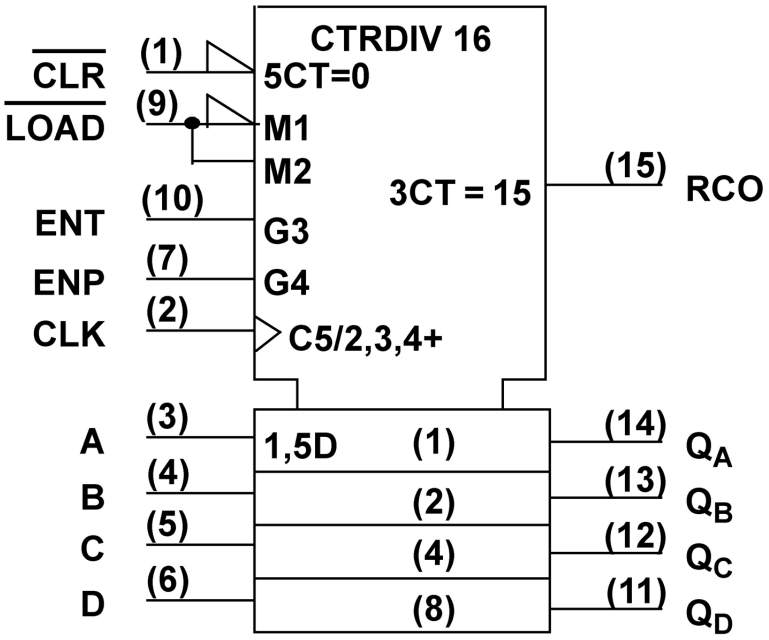


16-Lead Flatpack
Top View

4-Bit Synchronous Counters

UT54ACS163/UT54ACTS163

Logic Symbol



Note:

1) Logic symbol in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Function Table

Operating Mode	$\overline{CLR}$	CLK	ENP	ENT	$\overline{LOAD}$	DATA A,B,C,D	Q_N	RCO
Reset (Clear)	l	↑	X	X	X	X	L	L
Parallel Load	h^3 h^3	↑ ↑	X X	X X	l l	l h	L H	L 1
Count	h^3	↑	h	h	h	X	Count	1
Inhibit	h^3 h^3	X X	l^2 X	X l^2	h^3 h^3	X X	Q_N Q_N	1 L

H = High voltage level h = High voltage level one setup time prior to the low-to-high clock transition
L = Low voltage level l = Low voltage level one setup time prior to the low-to-high clock transition

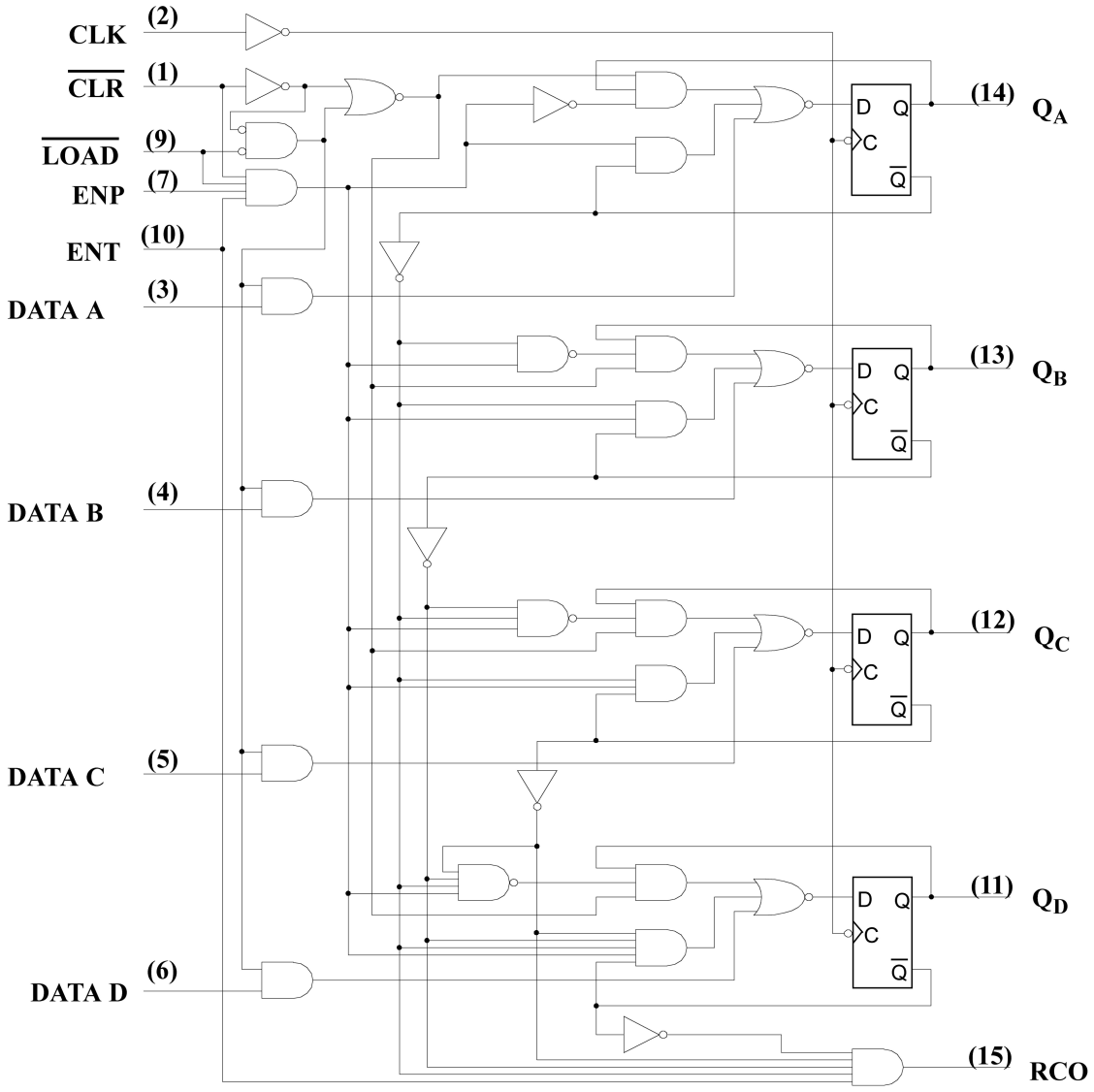
Notes:

1) The RCO output is high when ENT is high and the counter is at terminal count HHHH.
2) The high-to-low transition of ENP or ENT should only occur while CLK is high for conventional operations.
3) The low-to-high transition of $\overline{LOAD}$ or $\overline{CLR}$ should only occur while CLK is high for conventional operations.

4-Bit Synchronous Counters

UT54ACS163/UT54ACTS163

Logic Diagram



4-Bit Synchronous Counters

UT54ACS163/UT54ACTS163

Operational Environment [1]

Parameter	Limit	Units
Total Dose	1.0E6	rads(Si)
SEU Threshold [2]	80	MeV-cm^2/mg
SEL Threshold	120	MeV-cm^2/mg
Neutron Fluence	1.0E14	n/cm^2

Notes:

1) Logic will not latchup during radiation exposure within the limits defined in the table.
2) Device storage elements are immune to SEU affects.

Absolute Maximum Ratings

Symbol	Parameter	Limit	Units
V_{DD}	Supply voltage	-0.3 to 7.0	V
$V_{I/O}$	Voltage any pin	-.3 to V_{DD} +.3	V
T_{STG}	Storage Temperature range	-65 to +150	°C
T_J	Maximum junction temperature	+175	°C
T_{LS}	Lead temperature (soldering 5 seconds)	+300	°C
Θ_{JC}	Thermal resistance junction to case	20	°C/W
I_I	DC input current	±10	mA
P_D	Maximum power dissipation	1	W

Note:

1) Stresses outside the listed absolute maximum ratings may cause permanent damage to the device. This is a stress rating only, functional operation of the device at these or any other conditions beyond limits indicated in the operational sections is not recommended. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Recommended Operating Conditions

Symbol	Parameter	Limit	Units
V_{DD}	Supply voltage	4.5 to 5.5	V
V_{IN}	Input voltage any pin	0 to V_{DD}	V
T_C	Temperature range	-55 to + 125	°C

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DC Electrical Characteristics [7]

(V_{DD} = 5.0V ±10%; V_{SS} = 0V [6], -55°C < T_C < +125°C); Unless otherwise noted, Tc is per the temperature range ordered.

Symbol	Parameter	Condition	MIN	MAX	Unit
V_{IL}	Low-level input voltage [1] ACTS ACS			0.8 .3V_{DD}	V
V_{IH}	High-level input voltage [1] ACTS ACS		.5V_{DD} .7V_{DD}		V
I_{IN}	Input leakage current ACTS/ACS	V_{IN} = V_{DD} or V_{SS}	-1	1	µA
V_{OL}	Low-level output voltage [3] ACTS ACS	I_{OL} = 8.0mA I_{OL} = 100µA		0.40 0.25	V
V_{OH}	High-level output voltage [3] ACTS ACS	I_{OH} = -8.0mA I_{OH} = -100µA	.7V_{DD} V_{DD} - 0.25		V
I_{OS}	Short-circuit output current [2,4] ACTS/ACS	V_O = V_{DD} and V_{SS}	-200	200	mA
I_{OL}	Output current[10] (sink)	V_{IN} = V_{DD} or V_{SS} V_{OL} = 0.4V	8		mA
I_{OH}	Output current[10] (source)	V_{IN} = V_{DD} or V_{SS} V_{OH} = V_{DD} - 0.4V	-8		mA
P_{total}	Power dissipation [2, 8, 9]	C_L = 50pF		1.9	mW/MHz
I_{DDQ}	Quiescent Supply Current	V_{DD} =5.5V		10	µA
ΔI_{DDQ}	Quiescent Supply Current Delta ACTS	For input under test V_{IN} = V_{DD} - 2.1 For all other inputs V_{IN} = V_{DD} or V_{SS} V_{DD} = 5.5V		1.6	mA
C_{IN}	Input capacitance [5]	f = 1MHz @0V		15	pF
C_{OUT}	Output capacitance [5]	f = 1MHz @0V		15	pF

Notes:

1) Functional tests are conducted in accordance with MIL-STD-883 with the following input test conditions: V_{IH} = V_{IH}(min) + 20%, - 0%; V_{IL} = V_{IL}(max) + 0%, - 50%, as specified herein, for TTL, CMOS, or Schmitt compatible inputs. Devices may be tested using any input voltage within the above specified range, but are guaranteed to V_{IH}(min) and V_{IL}(max).
2) Supplied as a design limit but not guaranteed or tested.
3) Per MIL-PRF-38535, for current density ≤ 5.0E5 amps/cm^2, the maximum product of load capacitance (per output buffer) times frequency should not exceed 3,765pF/MHz.
4) Not more than one output may be shorted at a time for maximum duration of one second.
5) Capacitance measured for initial qualification and when design changes may affect the value. Capacitance is measured between the designated terminal and V_{SS} at frequency of 1MHz and a signal amplitude of 50mV rms maximum.
6) Maximum allowable relative shift equals 50mV.
7) All specifications valid for radiation dose ≤ 1E6 rads(Si).
8) Power does not include power contribution of any TTL output sink current.

9) Power dissipation specified per switching output.
10) This value is guaranteed based on characterization data, but not tested.

AC Electrical Characteristics [2]

(V_{DD} = 5.0V ±10%; V_{SS} = 0V [1]; -55°C < T_C < +125°C); Unless otherwise noted, Tc is per the temperature range ordered.

Symbol	Parameter	Minimum	Maximum	Unit
t_{PHL}	CLK to Q_n	4	24	ns
t_{PLH}	CLK to Q_n	4	22	ns
t_{PHL}	CLK to RCO	4	22	ns
t_{PLH}	CLK to RCO	4	24	ns
t_{PHL}	ENT to RCO	1	13	ns
t_{PLH}	ENT to RCO	1	14	ns
f_{MAX}	Maximum clock frequency		77	MHz
t_{SU1}	A, B, C, D Setup time before CLK↑	6		ns
t_{SU2}	$\overline{LOAD}$, ENP, ENT, $\overline{CLR}$ low or high Setup time before CLK ↑	6		ns
t_{H1} [3]	Data hold time after CLK ↑	1		ns
t_{H2}	All synchronous inputs hold time after CLK ↑	1		ns
t_W	Minimum pulse width $\overline{CLR}$ low CLK high CLK low	7		ns

Notes:

1) Maximum allowable relative shift equals 50mV.
2) All specifications valid for radiation dose ≤ 1E6 rads(Si).
3) Based on characterization, hold time (t_{H1}) of 0ns can be assumed if data setup time (t_{SU1}) is ≥ 10ns. This is guaranteed, but not tested.

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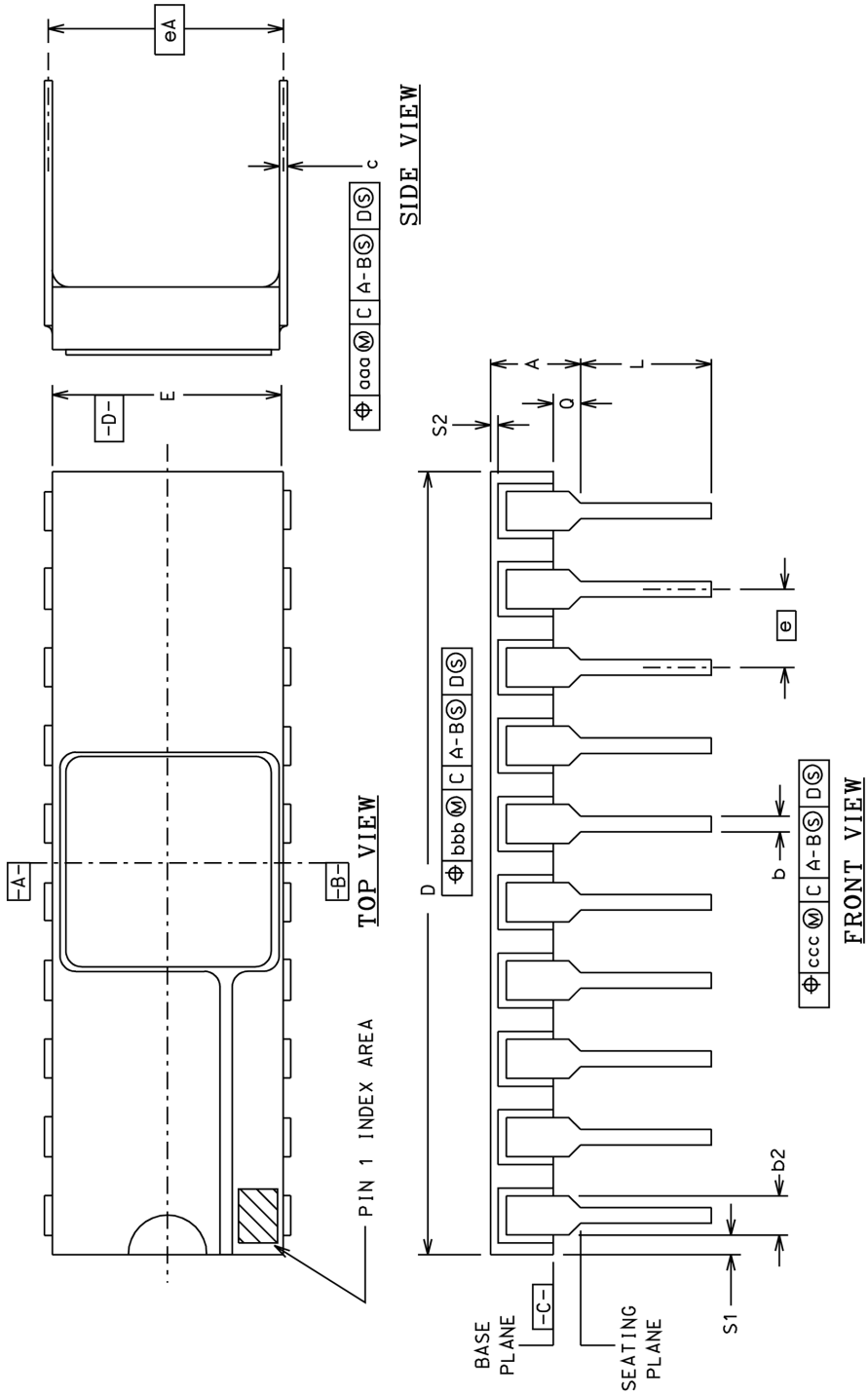
Packaging

Side-Brazed Packages



PKG CONFIG	LEAD COUNT	MIL-STD-1835 DWG CONF C	DIMENSION SYMBOLS																			
			A	b	b2	c	D	E	e	eA	L	Q	S1	S2	aaa	bbb	ccc
-01	14	D-1	0.200 -----	0.026 0.014	0.065 0.045	0.018 0.008	0.785 -----	0.310 0.220	0.100 BSC	0.300 BSC	0.200 0.125	0.060 0.015	----- 0.005	----- 0.005	0.015 -----	0.030 -----	0.010 -----
-02	16	D-2	0.200 -----	0.026 0.014	0.065 0.045	0.018 0.008	0.840 -----	0.310 0.220	0.100 BSC	0.300 BSC	0.200 0.125	0.060 0.015	----- 0.005	----- 0.005	0.015 -----	0.030 -----	0.010 -----
-03	20	D-8	0.200 -----	0.026 0.014	0.065 0.045	0.018 0.008	1.060 -----	0.310 0.220	0.100 BSC	0.300 BSC	0.200 0.125	0.070 0.015	----- 0.005	----- 0.005	0.015 -----	0.030 -----	0.010 -----

4-Bit Synchronous Counters

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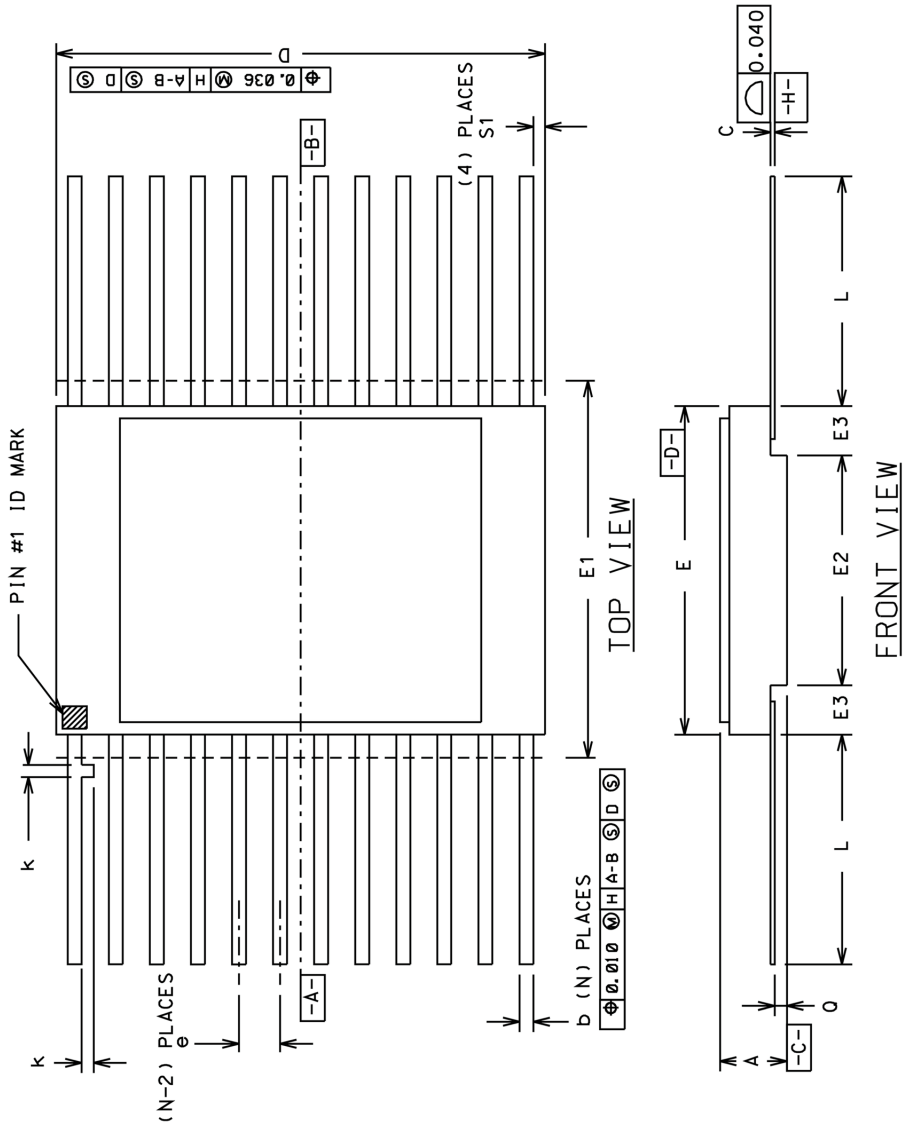
Flatpack Packages

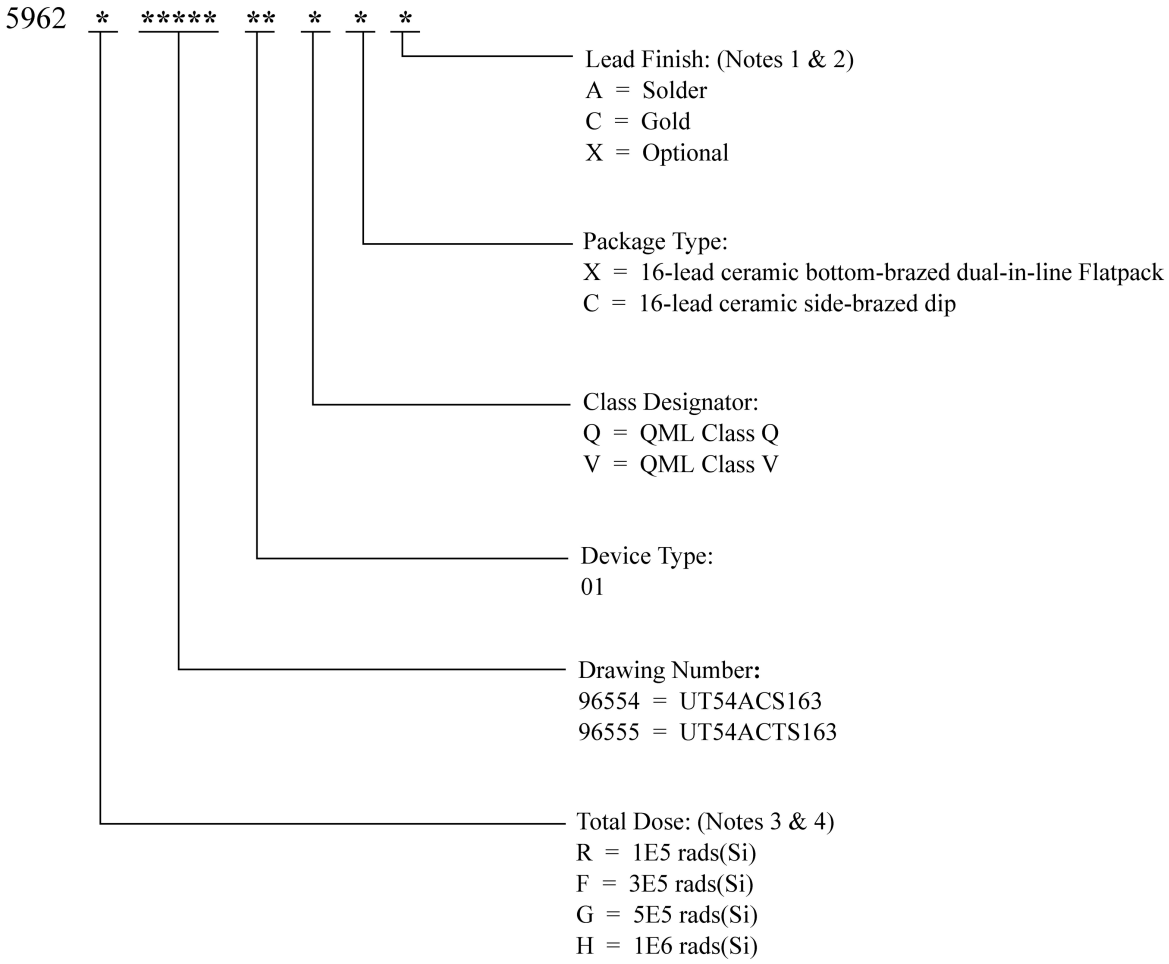


PKG CONFIG	LEAD COUNT	MIL-STD 1835 DWG CONF B	DIMENSION SYMBOLS																
			A	b	c	D	E	E1	E2	E3	e	k	L	Q	S1
-03	14	F-2A	0.115 0.045	0.022 0.015	0.009 0.004	0.390 -----	0.260 0.235	0.290 -----	----- 0.130	----- 0.030	0.050 BSC	0.015 0.008	0.370 0.270	0.045 0.026	----- 0.005
-04	16	F-5A	0.115 0.045	0.022 0.015	0.009 0.004	0.440 -----	0.285 0.245	0.315 -----	----- 0.130	----- 0.030	0.050 BSC	0.015 0.008	0.370 0.250	0.045 0.026	----- 0.005
-05	20	F-9A	0.115 0.045	0.022 0.015	0.009 0.004	0.540 -----	0.300 0.245	0.330 -----	----- 0.130	----- 0.030	0.050 BSC	0.015 0.008	0.370 0.250	0.045 0.026	----- 0.000

4-Bit Synchronous Counters

UT54ACS163/UT54ACTS163

UT54ACS163/UT54ACTS163: SMD



Notes:

1) Lead finish (A,C, or X) must be specified.
2) If an "X" is specified when ordering, part marking will match the lead finish and will be either "A" (solder) or "C" (gold).
3) Total dose radiation must be specified when ordering. QML Q and QML V not available without radiation hardening. For prototype inquiries, contact factory.
4) Device type 02 is only offered with a TID tolerance guarantee of 3E5 rads(Si) or 1E6 rads(Si) and is tested in accordance with MIL-STD-883 Test Method 1019 Condition A and section 3.11.2. Device type 03 is only offered with a TID tolerance guarantee of 1E5 rads(Si), 3E5 rads(Si), and 5E5 rads(Si), and is tested in accordance with MIL-STD-883 Test Method 1019 Condition A.

DATASHEET

RELEASED 11/10

4-Bit Synchronous Counters

UT54ACS163/UT54ACTS163

Datasheet Definitions

	DEFINITION
Advanced Datasheet	CAES reserves the right to make changes to any products and services described herein at any time without notice. The product is still in the development stage and the datasheet **is subject to change**. Specifications can be **TBD** and the part package and pinout are **not final**.
Preliminary Datasheet	CAES reserves the right to make changes to any products and services described herein at any time without notice. The product is in the characterization stage and prototypes are available.
Datasheet	Product is in production and any changes to the product and services described herein will follow a formal customer notification process for form, fit or function changes.

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